### imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

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ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

#### **Features**

- White SMD package, silicone resin.
- Low thermal resistance.
- Compatible with IR-reflow processes.
- ESD protection.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 2a.
- · RoHS compliant.

#### 3.5x3.5 mm SMD CHIP LED LAMP

Part Number: AA3535ZG25Z1S

Green

#### Description

The Green source color devices are made with InGaN on Al<sub>2</sub>O<sub>3</sub> substrate Light Emitting Diode.

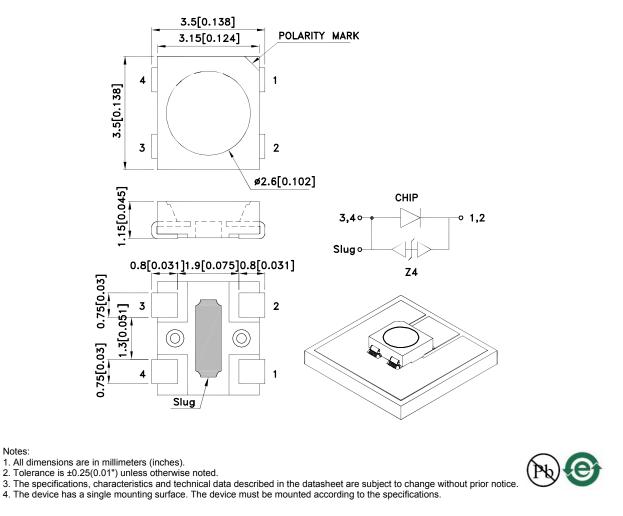
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

#### Applications

- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Commercial and residential lighting.
- Automotive interior lighting.



SPEC NO: DSAK3202 **APPROVED: WYNEC** 

Notes:

**REV NO: V.8B CHECKED: Allen Liu** 

DATE: FEB/02/2013 DRAWN: Q.M.CHEN

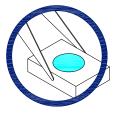
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#### **Package Dimensions**

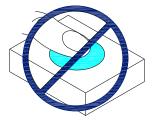
#### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

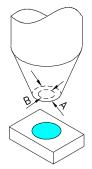




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as  $H_2S$  might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

All design applications should refer to Kingbright application notes available at <a href="http://www.KingbrightUSA.com/ApplicationNotes">http://www.KingbrightUSA.com/ApplicationNotes</a>

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#### **Selection Guide**

Part No.	Dice	Lens Type	lv (cd) [2] @ 150mA		Φν (lm) [2] @ 150mA*		Viewing Angle [1]
			Min.	Тур.	Min.	Тур.	2 0 1/2
AA3535ZG25Z1S	Green (InGaN)	Water Clear	4.2	6	14	20	120 °

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity/ luminous Flux: +/-15%.\*LEDs are binned according to their luminous flux.
Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	PD	600	mW
Junction Temperature [1]	ature [1] TJ 110		°C
Operating Temperature	Тор	-40 To +85	°C
Storage Temperature	Tstg	-40 To +85	°C
DC Forward Current [1]	lF	150	mA
Reverse Voltage	VR	5	V
Peak Forward Current [2]	Іғм	300	mA
Thermal Resistance [1] (Junction/ambient)	Rth j-a	170	°C/W
Thermal Resistance [1] (Junction/solder point)	Rth j-S	50	°C/W
Electrostatic Discharge Threshold (HBM)	8000	V	

Notes:

1. Results from mounting on PC board FR4(pad size  $\ge$  70mm<sup>2</sup>), mounted on pc board-metal core PCB is recommend

for lowest thermal Resistance.

2.1/10 Duty Cycle, 0.1ms Pulse Width.

#### Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Value	Unit
Wavelength at peak emission IF=150mA [Typ.]	λ peak	515	nm
Dominant Wavelength IF=150mA [Typ.]	λ dom [1]	525	nm
Spectral Line Half-width IF=150mA [Typ.]	Δλ	30	nm
Forward Voltage IF=150mA [Min.]		2.9	V
Forward Voltage IF=150mA [Typ.]	VF [2]	3.5	
Forward Voltage IF=150mA [Max.]		4.0	
Allowable Reverse Current [Max.]	lr	85	mA
Temperature coefficient of $\lambda$ peak IF=150mA, -10 $^\circ$ C $\leq$ T $\leq$ 100 $^\circ$ C [Typ.]	TC $\lambda$ peak	0.09	nm/° C
Temperature coefficient of $\lambda$ dom IF=150mA, -10 $^\circ$ C ≤ T≤100 $^\circ$ C [Typ.]	TC λ dom	0.03	nm/° C
Temperature coefficient of VF IF=150mA, -10 $^{\circ}$ C $\leq$ T $\leq$ 100 $^{\circ}$ C [Typ.]	TCv	-2.7	mV/° C

Notes:

1.Wavelength: +/-1nm.

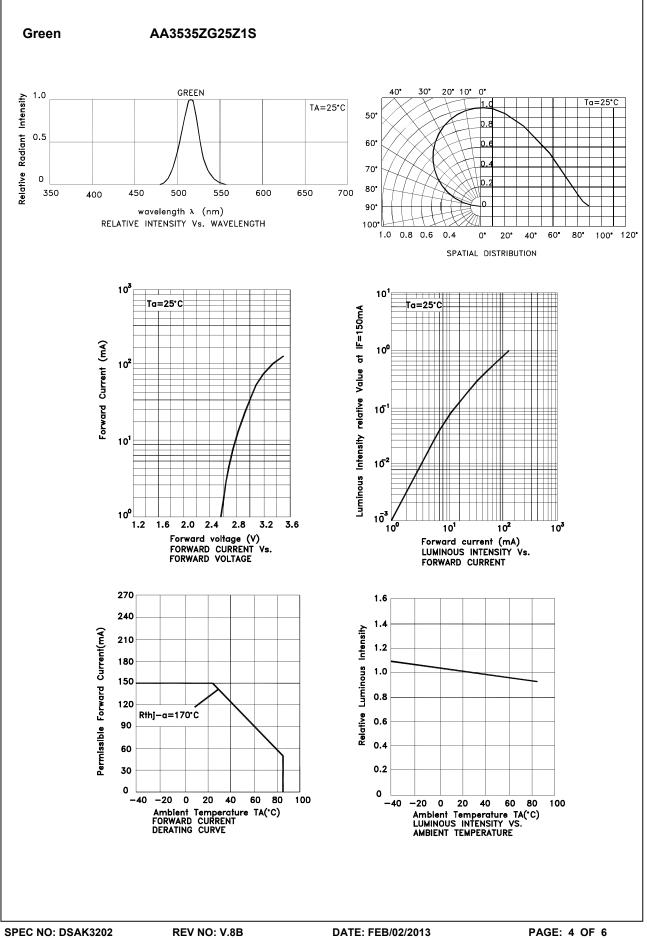
2. Forward Voltage: +/-0.1V.

3.Wavelength value is traceable to the CIE127-2007 compliant national standards.

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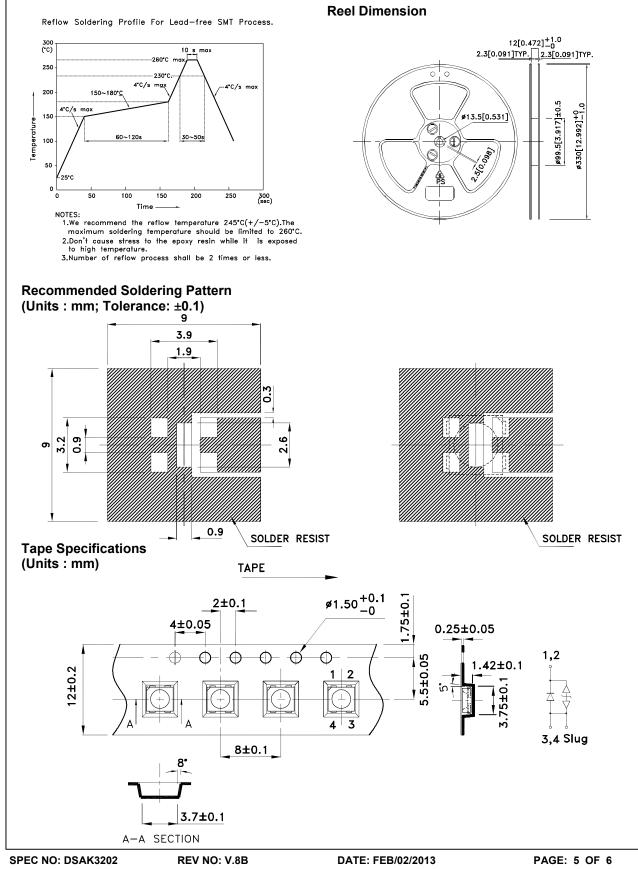
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#### AA3535ZG25Z1S

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.



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